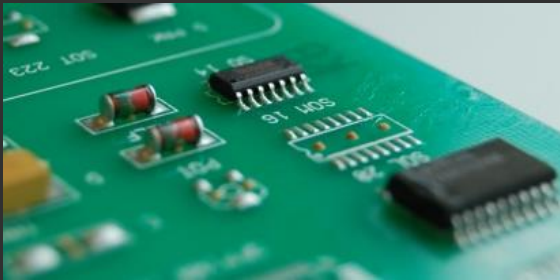




# IQ-BOND

SMD Adhesives, developed and produced in Europe!

SMD-Kleber, entwickelt und gefertigt in Europa!



SMA	Cure	Viscosity (mPa.s)	Hardness	Worklife	Application Method(s)
IQ-BOND 2200 (Yellow)	1-2 min @ 150°C 5 min @ 120°C 30 min @ 80°C	150.000	85 D	5 days	Printing Dispensing/Jetting Stamping
IQ-BOND 2400 (Yellow)	1-2 min @ 150°C 5 min @ 120°C	150.000	85 D	10 days	Printing Dispensing
IQ-BOND 2401 (Yellow)	1-2 min @ 150°C 5 min @ 120°C	80.000	85-D	5 days	Jetting High-Speed dispensing
IQ-BOND 3200 (Red)	1-2 min @ 150°C 5 min @ 120°C 30 min @ 80°C	150.000	85 D	5 days	Printing Dispensing / Jetting Stamping
IQ-BOND 3202 (Red)	1-2 min @ 150°C 5 min @ 120°C	600.000	85 D	5 days	Printing
IQ-BOND 3400 (Red)	1-2 min @ 150°C 5 min @ 120°C	150.000	85 D	10 days	Printing Dispensing
IQ-BOND 3401 (Red)	1-2 min @ 150°C 5 min @ 120°C	80.000	85 D	5 days	Jetting High-Speed dispensing

IQ-BOND SMD adhesives are suitable for:

- Double sided SMT technology
- Mixed technology boards, small & large components



Unique Features of IQ-BOND SMD adhesives:

- Faster cure compared to conventional SMD adhesives, resulting in faster throughput processes
- High-speed printing, as well as dispensing, and small-dot jetting applications
- Compatible with Pb-free soldering processes
- REACH / ROHS compliant
- High dot profiles, High green strength
- Best-in-class process repeatability
- Available in syringes (10 cc, 30 cc), cartridges (350gr) and/or jars

Or your local distributing partner

